

SWITCHMODE [™] **Series NPN Silicon Power Transistor**

... designed for high speed, high current, high power applications.

• High DC current gain:

$$h_{FE}$$
 min = 20 at I_C = 25 A = 10 at I_C = 50 A

• Low V_{CE(sat)}:

$$\begin{split} &V_{CE(sat)} \text{ max.} = 0.6 \text{ V at } I_C = 25 \text{ A} \\ &= 0.9 \text{ V at } I_C = 50 \text{ A} \end{split}$$

• Very fast switching times:

$$T_F = 0.25 \ \mu s \ at \ I_C = 50 \ A$$

MAXIMUM RATINGS

| Rating | Symbol | BUV20 | BUV60 | Unit |
|--|-----------------------------------|------------|-------|------------|
| Collector–Emititer Voltage | V _{CEO(sus)} | 125 | | Vdc |
| Collector–Base Voltage | V _{CBO} | 160 | 260 | Vdc |
| Emitter–Base Voltage | V_{EBO} | 7 | | Vdc |
| Collector–Emitter Voltage (V _{BE} = -1.5 V) | V _{CEX} | 160 | 260 | Vdc |
| Collector–Emitter voltage ($R_{BE} = 100 \Omega$) | V _{CER} | 150 | 260 | Vdc |
| Collector–Current — Continuous — Peak (PW ≤ 10 ms) | I _C I _{CM} | 50 60 | | Adc Apk |
| Base-Current continuous | I _B | 10 | | Adc |
| Total Power Dissipation @ T _C = 25°C | P _D | 250 | | Watts |
| Operating and Storage Junction Temperature Range | T _J , T _{stg} | -65 to 200 | | °C |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | BUV20 | BUV60 | Unit |
|--------------------------------------|----------------------|-------|-------|------|
| Thermal Resistance, Junction to Case | θ_{JC} | 0.7 | | °C/W |

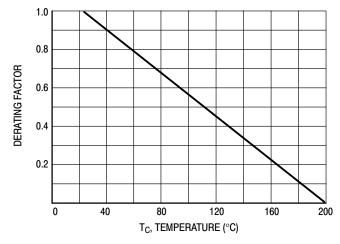


Figure 1. Power Derating

BUV20 BUV60

50 AMPERES
NPN SILICON
POWER
METAL TRANSISTOR
125 VOLTS
250 WATTS



CASE 197A-05 TO-204AE (TO-3)

BUV20 BUV60

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

| Characteristic | | Symbol | Min | Max | Unit |
|---|--|-----------------------|-----------|-------------------|------|
| OFF CHARACTERISTICS ¹ | | | • | • | • |
| Collector–Emitter Sustaining Vol (I _C = 200 mA, I _B = 0, L = 25 m | S . | V _{CEO(sus)} | 125 | | Vdc |
| Collector Cutoff Current at Reve $(V_{CE} = 140 \text{ V}, V_{BE} = -1.5 \text{ V})$ $(V_{CE} = 140 \text{ V}, V_{BE} = -1.5 \text{ V}, T_{CE} = 260 \text{ V}, V_{BE} = -1.5 \text{ V})$ | BUV20 | I _{CEX} | | 3.0 12 | mAdo |
| Collector–Emitter Cutoff Current (V _{CE} = 100 V) | BUV20 | I _{CEO} | | 3.0 | mAdo |
| Emitter–Base Reverse Voltage (I _E = 50 mA) | BUV20, BUV60 | V _{EBO} | 7 | | V |
| Emitter–Cutoff Current (V _{EB} = 5 V) BUV20 | | I _{EBO} | | 1.0 | mAdo |
| SECOND BREAKDOWN | | | <u>'</u> | 1 | • |
| Second Breakdown Collector Current with base forward biased (V _{CE} = 20 V, t = 1 s) (V _{CE} = 40 V, t = 1 s) | | I _{S/b} | 12 1.5 | | Adc |
| ON CHARACTERISTICS ¹ | | | <u>I</u> | I | |
| DC Current Gain ($I_C = 25 \text{ A}, V_{CE} = 2 \text{ V}$) ($I_C = 50 \text{ A}, V_{CE} = 4 \text{ V}$) | BUV20 BUV20 | h _{FE} | 20 10 | 60 - | |
| Collector–Emitter Saturation Vol ($I_C = 25 \text{ A}, I_B = 2.5 \text{ A}$) ($I_C = 50 \text{ A}, I_B = 5 \text{ A}$) | tage BUV20 BUV20 | V _{CE(sat)} | | 0.6 1.2 | Vdc |
| Base–Emitter Saturation Voltage $(I_C = 50 \text{ A}, I_B = 5 \text{ A})0$ | | V _{BE(sat)} | | 2.0 | Vdc |
| | tage BUV60 BUV60 BUV60 | V _{CE(sat)} | | 0.9 0.9 1.2 | Vdc |
| Base–Emitter Saturation Voltage $(I_C = 50 \text{ A}, I_B = 5 \text{ A})$ $(I_C = 60 \text{ A}, I_B = 7.5 \text{ A})$ | | V _{BE(sat)} | | 1.6 1.8 | Vdc |
| DYNAMIC CHARACTERISTICS | - | | | | • |
| Current Gain — Bandwidth Prod ($V_{CE} = 15 \text{ V}, I_{C} = 2 \text{ A}, f = 4 \text{ MHz}$ | | f _T | 8.0 | | MHz |
| SWITCHING CHARACTERISTIC | S (Resistive Load) | | | | |
| Turn-on Time | | t _{on} | | 1.5 | μs |
| Storage Time | $(I_C = 50 \text{ A}, I_{B1} = I_{B2} = 5 \text{ A}, V_{CC} = 30 \text{ V}, R_C = 0.6 \Omega)$ | ts | | 1.2 | |
| Fall Time | 00 / 10 / | t _f | | 0.25 | |

¹ Pulse Test: Pulse Width $\leq 300 \,\mu\text{s}$, Duty Cycle $\leq 2\%$.

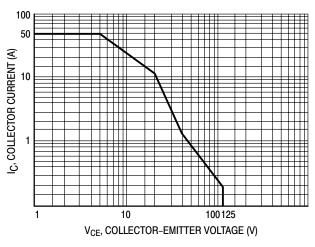


Figure 2. Active Region Safe Operating Area

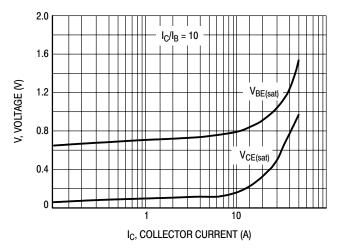


Figure 3. "On" Voltages

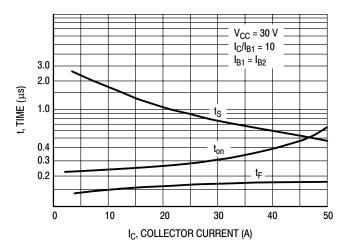


Figure 5. Resistive Switching Performance

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 2 is based on $T_C = 25^{\circ}C$. $T_{J(pk)}$ is variable depending on power level. Second breakdown limitations do not derate the same as thermal limitations.

At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

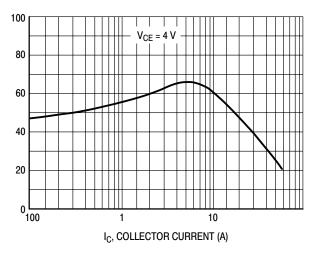
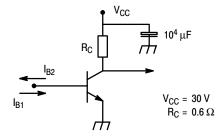


Figure 4. DC Current Gain



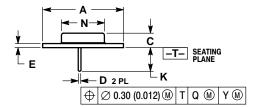
R_C — Non inductive resistance

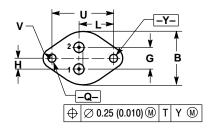
Figure 6. Switching Times Test Circuit

BUV20 BUV60

PACKAGE DIMENSIONS

TO-204AE (TO-3) CASE 197A-05 ISSUE J





NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI
 V14 FM 1082
- Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH

| | OONTHOLLING DIMENSION. INON. | | | | |
|-----|------------------------------|-----------|-------------|-----------|--|
| | INCHES | | MILLIMETERS | | |
| DIM | MIN | MAX | MIN | MAX | |
| Α | 1.530 | 1.530 REF | | 38.86 REF | |
| В | 0.990 | 1.050 | 25.15 | 26.67 | |
| С | 0.250 | 0.335 | 6.35 | 8.51 | |
| D | 0.057 | 0.063 | 1.45 | 1.60 | |
| E | 0.060 | 0.070 | 1.53 | 1.77 | |
| G | 0.430 BSC | | 10.92 BSC | | |
| Н | 0.215 | BSC | 5.46 BSC | | |
| K | 0.440 | 0.480 | 11.18 | 12.19 | |
| L | 0.665 BSC | | 16.89 BSC | | |
| N | 0.760 | 0.830 | 19.31 | 21.08 | |
| Q | 0.151 | 0.165 | 3.84 | 4.19 | |
| U | 1.187 BSC | | 30.15 BSC | | |
| ٧ | 0.131 | 0.188 | 3.33 | 4.77 | |

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